

NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP055N10G uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

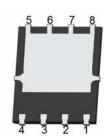
General Features

- V_{DS} =100V, I_D =105A $R_{DS(ON)}$ =4.9m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

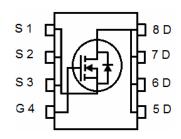
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	g Device	Device Package	Reel Size	Tape width	Quantity
P055N10G	NCEP055N10G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25°Cunless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	105	А	
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	78	А	
Pulsed Drain Current	I _{DM}	420	А	
Maximum Power Dissipation	P _D	120	W	
Derating factor		0.96	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	605	mJ	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	1.04	°C/W



Electrical Characteristics (T_C=25 °C unless otherwise noted)

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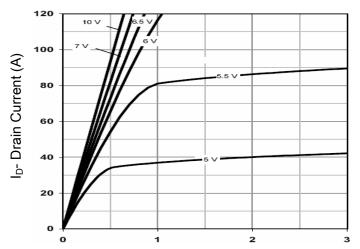
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =50A	-	4.9	5.5	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =50A		80	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -50\/\/ -0\/	-	3500	-	PF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V, F=1.0MHz	-	400	-	PF
Reverse Transfer Capacitance	C _{rss}	r-1.0Winz	-	19	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	19	-	nS
Turn-on Rise Time	t _r	V_{DD} =50 V , I_D =50 A ,	-	12	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{G} =3 Ω	-	38	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Qg	\/ _E0\/ _E0A	-	58	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =50V, I_{D} =50A, V_{GS} =10V	-	22		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	14		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =50A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	105	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =50A	-	59	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	104	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\!\!\mathrm{C}$,V $_{DD}$ =50 V ,V $_{G}$ =10 V ,L=0.5 mH ,Rg=25 Ω

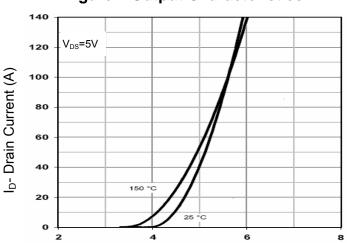


Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

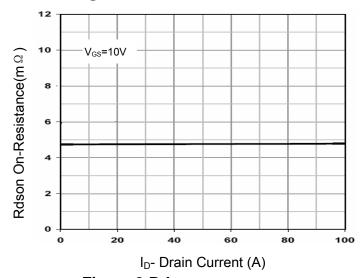
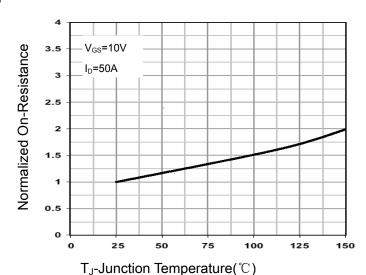


Figure 3 Rdson- Drain Current



1 Julius Tomporataro (c)

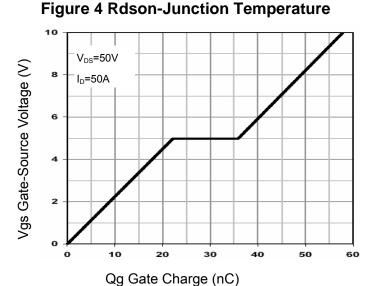
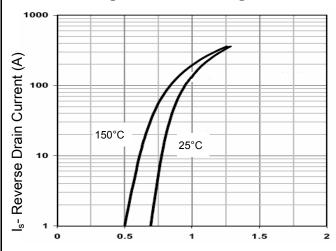


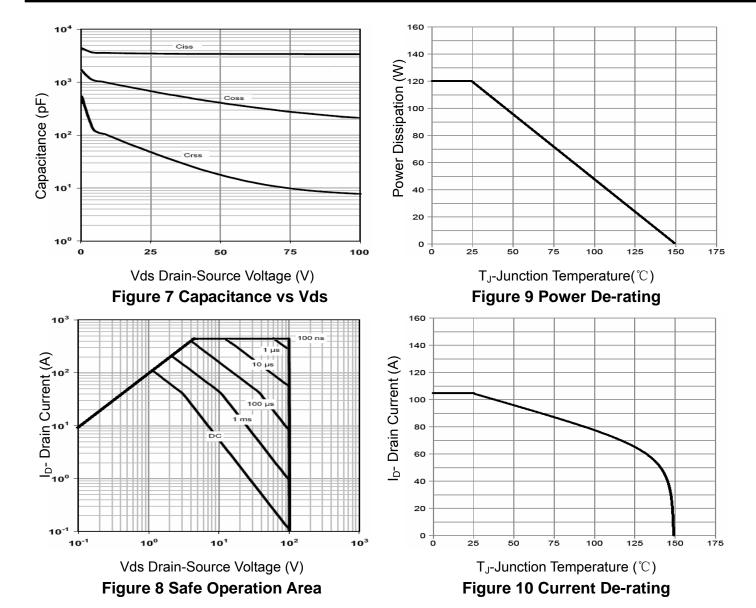
Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward





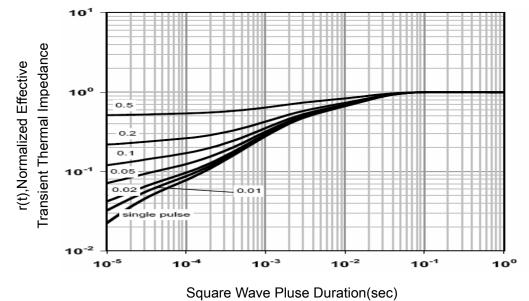
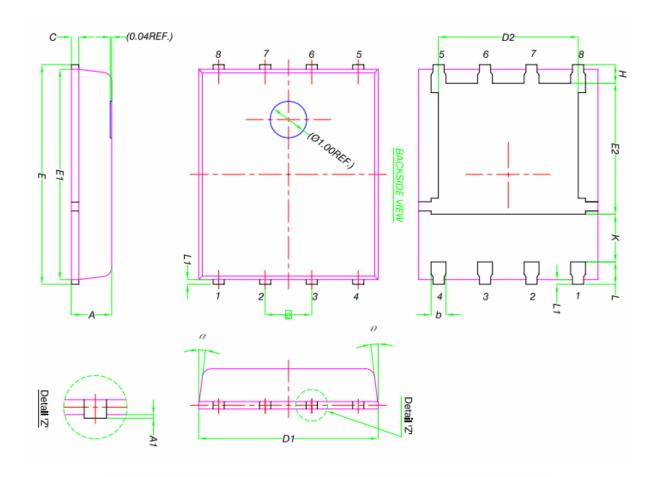


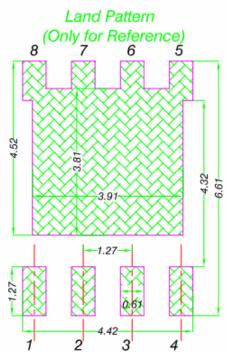
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



5	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
К	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	О° -		12°	



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NCEP055N10G

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